

for VendingRobotics  
by Bali Automation

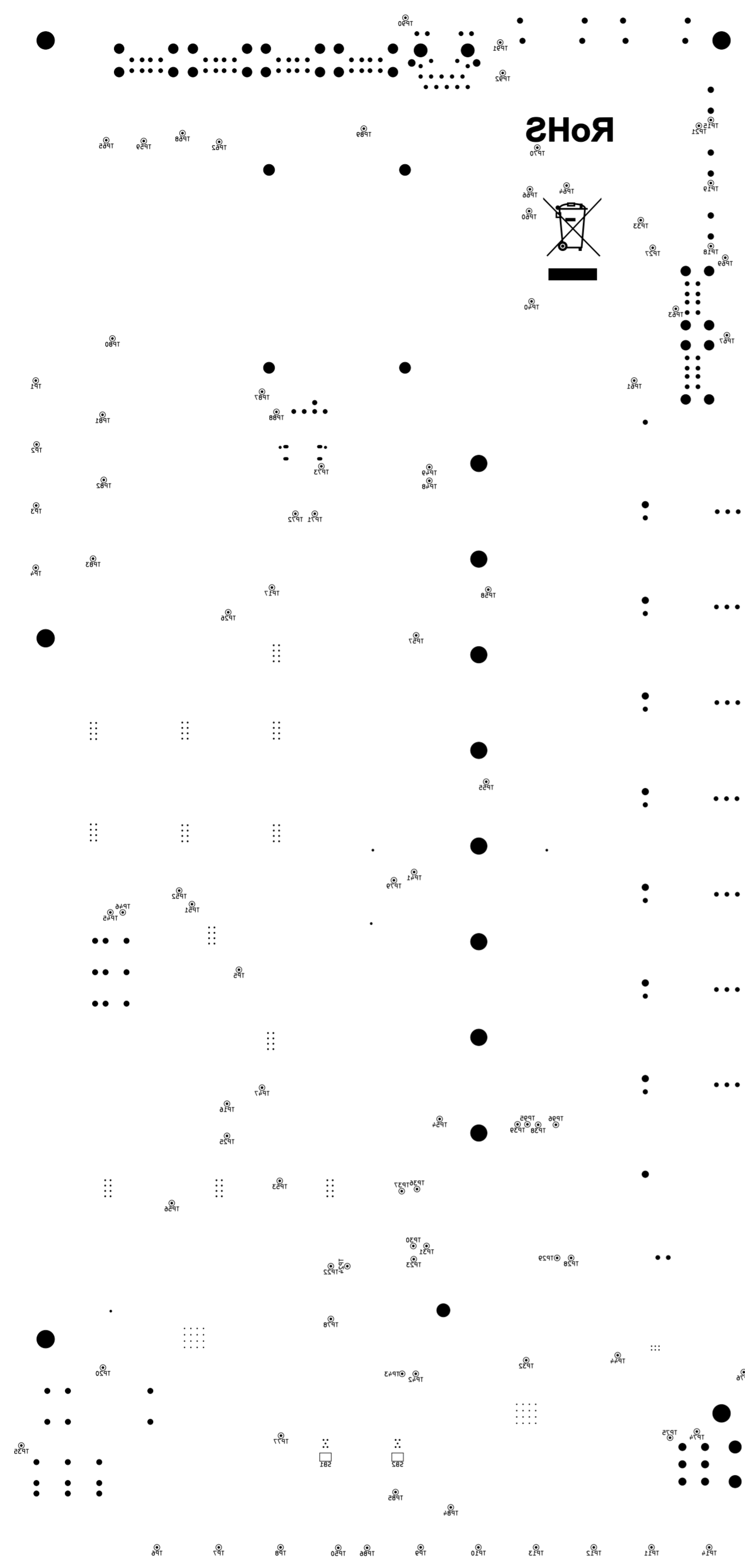
Sheet:  
File: Corey-VR-01.kicad\_pcb

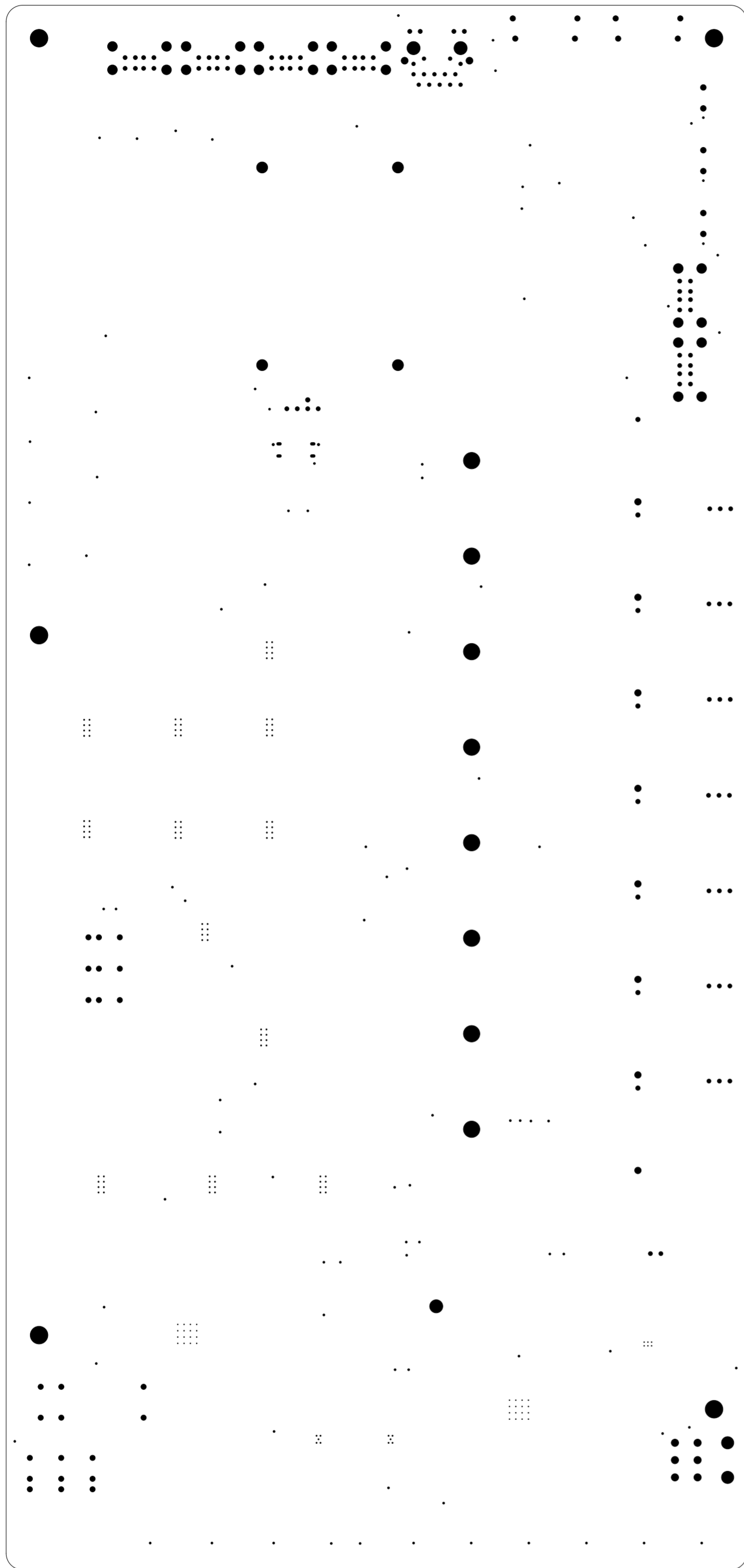
Title: **Corey-VR-01**

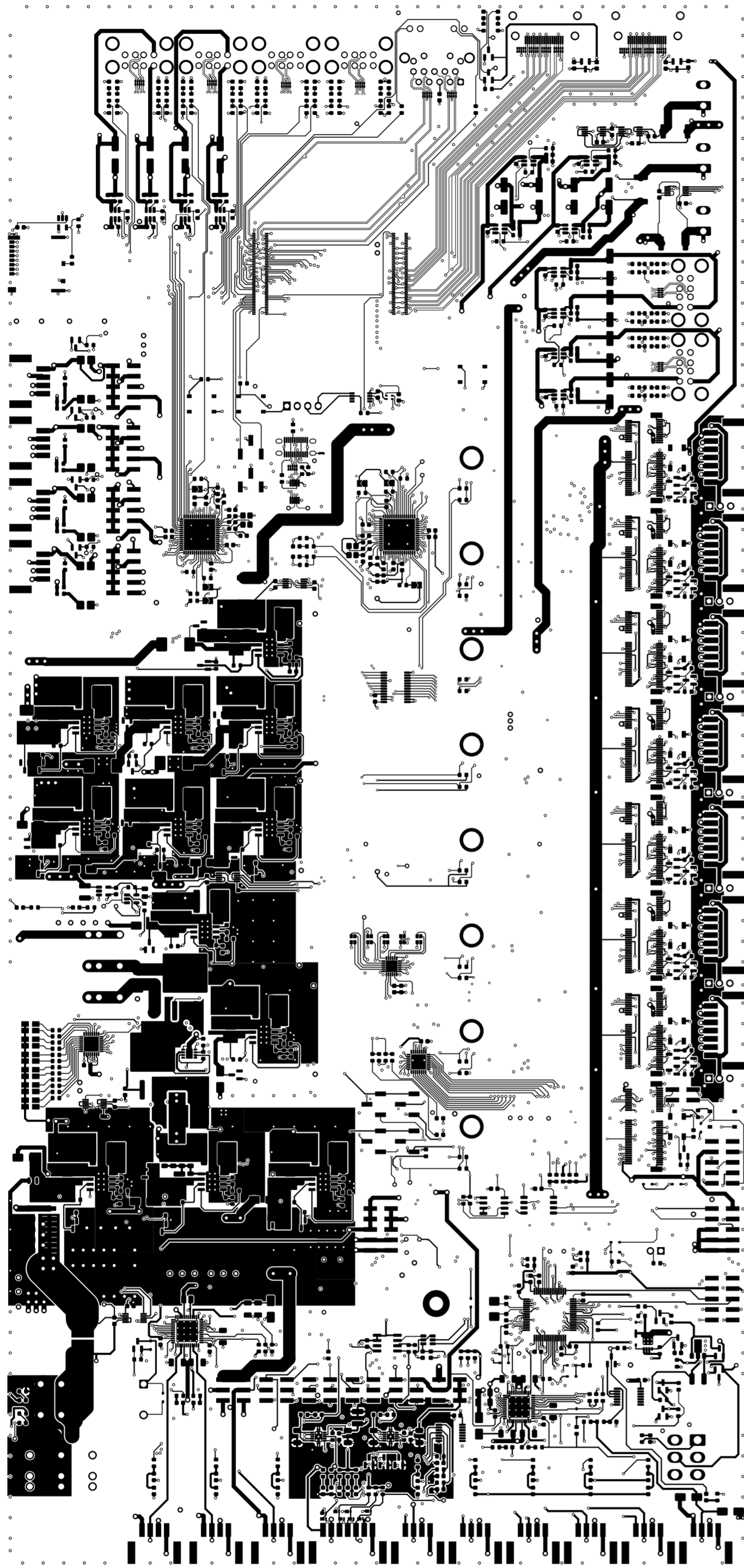
Size: A2 Date:

KiCad E.D.A. 9.0.6

Rev: 1  
Id: 1/1







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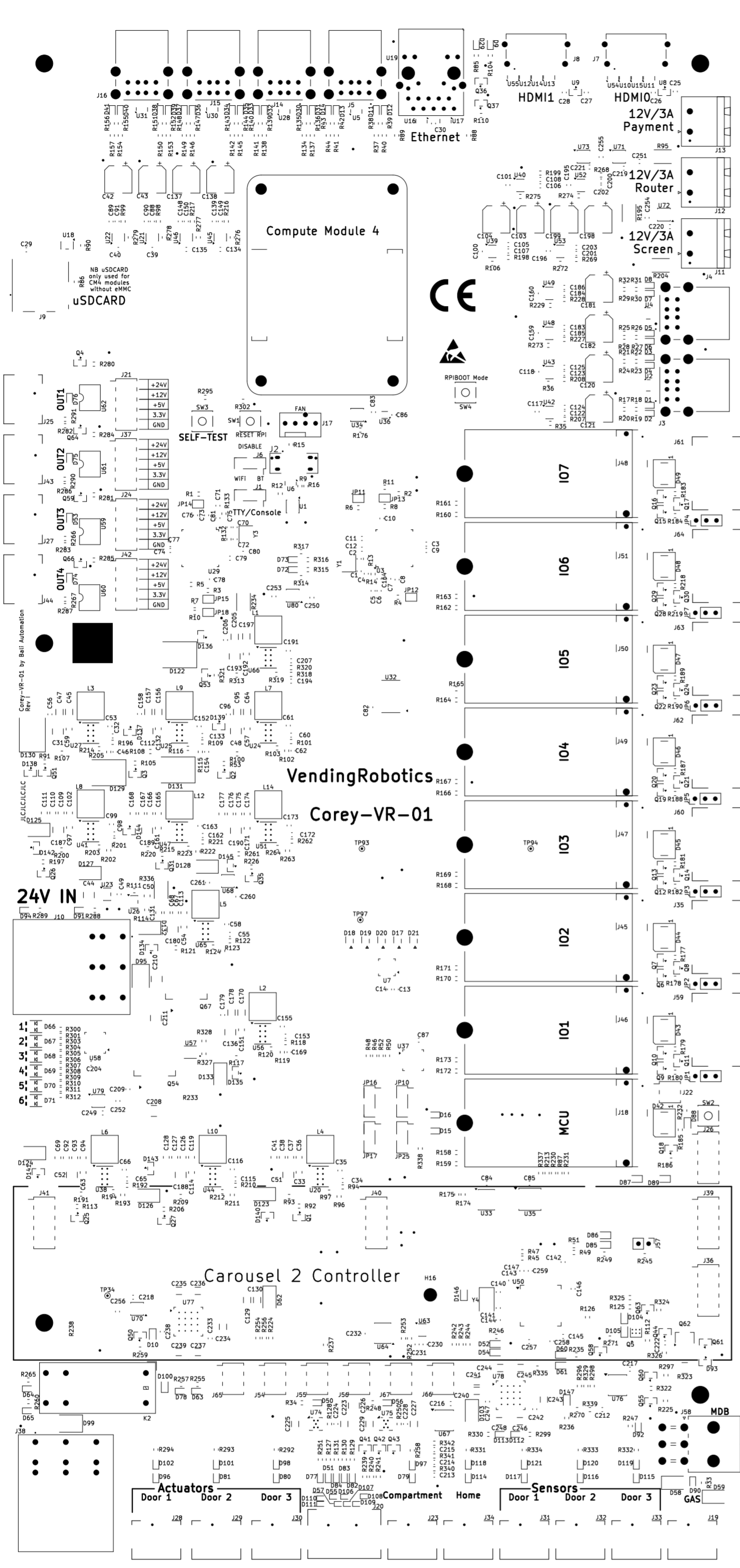
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**BOARD CHARACTERISTICS**

Copper Layer Count: 6 Board Thickness: 1.5584 mm  
 Board overall dimensions: 180.0000 mm x 380.0000 mm  
 Min track/spacing: 0.0889 mm / 0.0889 mm Min hole diameter: 0.2000 mm  
 Copper Finish: None Impedance Control: Yes  
 Castellated pads: No Plated Board Edge: No  
 Edge card connectors: No

**Advanced PCB, 6 layers, matched impedance, JLCPCB type: JLC06161H-3313A**

Layer Name	Type	Material	Thickness (mm)	Color	Epsilon R	Loss Tangent
F.Silkscreen	Top Silk Screen	Not specified	0 mm	White	1	0
F.Paste	Top Solder Paste	Not specified	0 mm	Blue	3.3	0
F.Mask	Top Solder Mask	Not specified	0.01 mm	Blue	3.3	0
F.Cu	copper	Not specified	0.035 mm	Blue	1	0
Dielectric	prepreg	FR4	0.0994 mm	Not specified	4.5	0.02
In1.Cu	copper	Not specified	0.0152 mm	Not specified	1	0
Dielectric	core	FR4	0.55 mm	Not specified	4.5	0.02
In2.Cu	copper	Not specified	0.0152 mm	Not specified	1	0
Dielectric	prepreg	FR4	0.1088 mm	Not specified	4.5	0.02
In3.Cu	copper	Not specified	0.0152 mm	Not specified	1	0
Dielectric	core	FR4	0.55 mm	Not specified	4.5	0.02
In4.Cu	copper	Not specified	0.0152 mm	Not specified	1	0
Dielectric	prepreg	FR4	0.0994 mm	Not specified	4.5	0.02
B.Cu	copper	Not specified	0.035 mm	Blue	1	0
B.Mask	Bottom Solder Mask	Not specified	0.01 mm	Blue	3.3	0
B.Paste	Bottom Solder Paste	Not specified	0 mm	Blue	3.3	0
B.Silkscreen	Bottom Silk Screen	Not specified	0 mm	White	1	0

